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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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SPECIFICATION

PART NO.: MT2030-HRG-A

3.0mm ROUND BI-POLAR LAMP (2 LEADS)

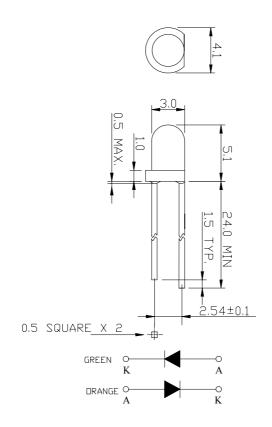




3.0mm ROUND BI-POLAR LAMP(2 LEADS)

Description

This green and orange bi-color lamp is made with GaP/GaP green chip, GaAsP/GaP orange chip and white diffused epoxy resin.



Notes:

- 1. ALL DIMENSIONS ARE IN mm.
- 2. TOLERANCE IS±0.25mm UNLESS OTHERWISE NOTED.

Description

Part No.	LED Cl		
	Material	Emitting Color	Lens Color
MT2030-HRG-A	GaP/GaP	Green	White diffused
	GaAsP/GaP	Red	winte diffused

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3.0mm ROUND BI-POLAR LAMP(2 LEADS)

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	78	mW
Reverse Voltage	VR	5	V
D.C. Forward Current	If	30	mA
Reverse (Leakage) Current	Ir	100	μА
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	If(Peak)	100	mA
Operating Temperature Range	Topr.	-25 to +85	°C
Storage Temperature Range	Tstg.	-40 to +100	°C
Lead Soldering Temp.(1.6mm from body) for 5 seconds		260	°C

Electrical and Optical Characteristics:

Green

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	Iv	If=20mA	3.0	7.0		mcd
Forward Voltage	Vf	If=20mA		2.1	2.6	V
Peak Wavelength	λΡ	If=20mA		567		nm
Dominant Wavelength	λD	If=20mA		572		nm
Reverse (Leakage) Current	Ir	Vr=5V			100	μΑ
Viewing Angle	2θ 1/2	If=20mA		118		deg
Spectrum Line Halfwidth	Δλ	If=20mA		30		nm

NOTE: THE DATAS TESTED BY IS TESTER

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3.0mm ROUND BI-POLAR LAMP(2 LEADS)

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	78	mW
Reverse Voltage	VR	5	V
D.C. Forward Current	If	30	mA
Reverse (Leakage) Current	Ir	100	μА
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	If(Peak)	100	mA
Operating Temperature Range	Topr.	-25 to +85	°C
Storage Temperature Range	Tstg.	-40 to +100	°C
Lead Soldering Temp.(1.6mm from body) for 5 seconds		260	°C

Electrical and Optical Characteristics:

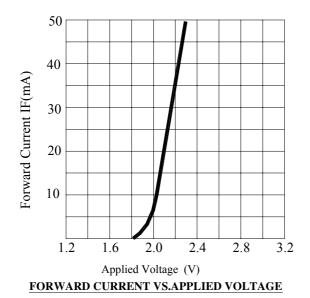
Red

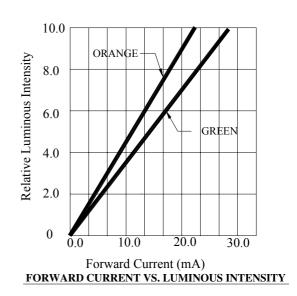
Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	Iv	If=20mA	4.29	9.0		mcd
Forward Voltage	Vf	If=20mA		2.1	2.6	V
Peak Wavelength	λΡ	If=20mA		635		nm
Dominant Wavelength	λD	If=20mA		626		nm
Reverse (Leakage) Current	Ir	Vr=5V			100	μΑ
Viewing Angle	2θ 1/2	If=20mA		118		deg
Spectrum Line Halfwidth	Δλ	If=20mA		35		nm

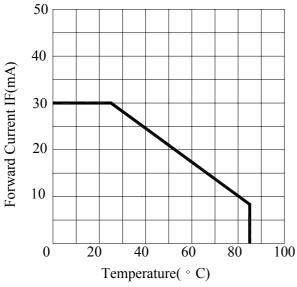
NOTE: THE DATAS TESTED BY IS TESTER

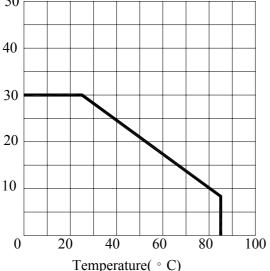
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Typical Electrical / Optical Characteristics Curves:

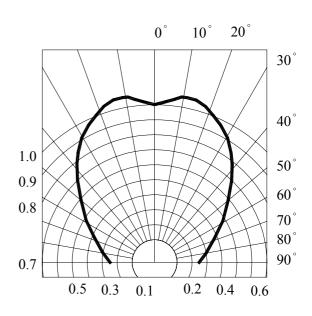








FORWARD CURRENT VS. AMBIENT TEMPERATURE



RADIATION DIAGRAM

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3.0mm ROUND BI-POLAR LAMP(2 LEADS)

Precautions:

TAKE NOTE OF THE FOLLOWING IN USE OF LED

1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130°C.

At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

- (2) Solder dip: Preheat: 90°C max. (Backside of PCB), Within 120 seconds Solder bath: 250°C max. (Solder temperature), Within 5 seconds
- (3) Soldering iron: 250°C max. (Temperature of soldering iron tip), Within 3 seconds

3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same

4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120°C max. Baking time: Within 60 seconds

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

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